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| FAIRCI<br>SEMICOND<br>FDC6302P  | DUCTOR                                 |  |          |         | October 1997 |
|---|--|--|----------|---------|--------------|
| •   | Γ, Dual P-Chanr                        | nel  | Features |         |              |
| General Description<br>These Dual P-Channel logic level enhancement mode field effect<br>transistors are produced using Fairchild's proprietary, high cell<br>density, DMOS technology. This very high density process is<br>especially tailored to minimize on-state resistance. This device<br>has been designed especially for low voltage applications as a<br>replacement for digital transistors in load switchimg applications.<br>Since bias resistors are not required this one P-Channel FET<br>can replace several digital transistors with different bias resistors<br>like the IMBxA series. |  | <ul> <li>-25 V, -0.12 A continuous, -0.5 A Peak.<br/>R<sub>DS(ON)</sub> = 13 Ω @ V<sub>GS</sub>= -2.7 V<br/>R<sub>DS(ON)</sub> = 10 Ω @ V<sub>GS</sub>= -4.5 V.     </li> <li>Very low level gate drive requirements allowing direct operation in 3V circuits. V<sub>GS(th)</sub> &lt; 1.5V.     </li> <li>Gate-Source Zener for ESD ruggedness.<br/>&gt;6kV Human Body Model     </li> <li>Replace multiple PNP digital transistors (IMHxA series) wi one DMOS FET.     </li> </ul> |          |         |              |
| <del>, A</del>  |  |  |          |         |              |
| SOT-23  | SuperSOT <sup>™</sup> -6               | SuperSOT <sup>™</sup> -8   | SO-8     | SOT-223 | SOIC-16      |
|   | D1<br>D1<br>SOT ™-6 <sup>pin1</sup> G1 | G2<br>S2   |          |         | 3            |

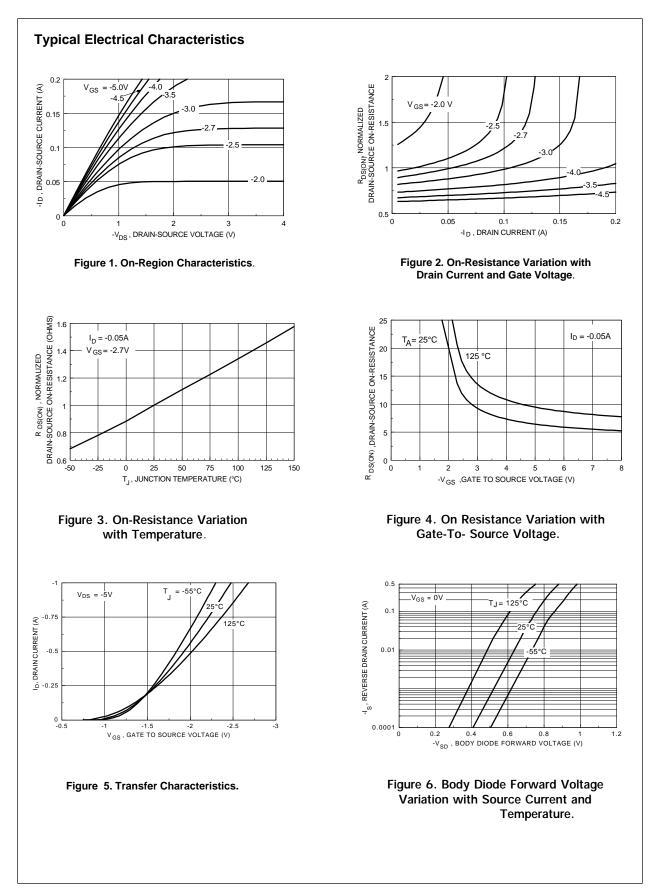
#### **Absolute Maximum Ratings** $T_{A} = 25^{\circ}C$ unless other wise noted

| Symbol                           | Parameter   |               | FDC6302P   | Units |  |
|----------------------------------|---|---------------|------------|-------|--|
| V <sub>DSS</sub>                 | Drain-Source Voltage  |               | -25        | V     |  |
| V <sub>GSS</sub>                 | Gate-Source Voltage   |               | -8         | V     |  |
| D                                | Drain Current - Continuous<br>- Pulsed                                      |               | -0.12      | A     |  |
|                                  |   |               | -0.5       |       |  |
| P <sub>D</sub>                   | Maximum Power Dissipation   | (Note 1a)     | 0.9        | W     |  |
|                                  |   | (Note 1b)     | 0.7        |       |  |
| Γ <sub>J</sub> ,T <sub>stg</sub> | Operating and Storage Temperature Ra  | ange          | -55 to 150 | °C    |  |
| ESD                              | Electrostatic Discharge Rating MIL-ST<br>Human Body Model (100pf / 1500 Ohr |               | 6.0        | kV    |  |
| THERMA                           | L CHARACTERISTICS   |               |            |       |  |
| R <sub>eja</sub>                 | Thermal Resistance, Junction-to-Ambie                                       | ent (Note 1a) | 140        | °C/W  |  |
| R <sub>ejc</sub>                 | Thermal Resistance, Junction-to-Case  | (Note 1)      | 60         | °C/W  |  |

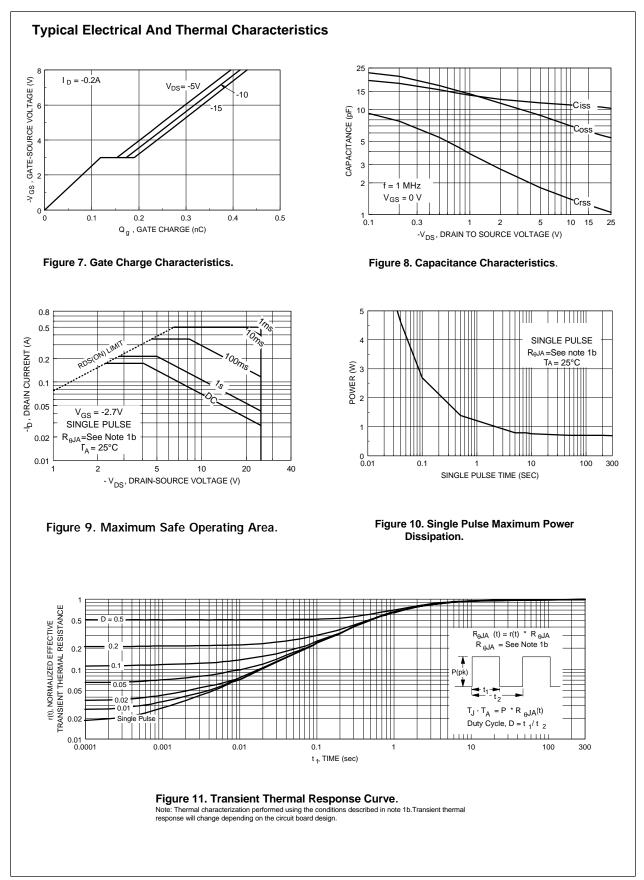
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| Symbol                             | Parameter  | Conditions   | Min   | Тур   | Max       | Units  |
|------------------------------------|--|--|-------|-------|-----------|--------|
| OFF CHAR                           | ACTERISTICS  |  |       |       |           |        |
| BV <sub>DSS</sub>                  | Drain-Source Breakdown Voltage   | $V_{GS} = 0 V, I_{D} = -250 \mu A$                               | -25   |       |           | V      |
| $\Delta BV_{DSS}/\Delta T_{J}$     | Breakdown Voltage Temp. Coefficient  | $I_{\rm D}$ = -250 µA, Referenced to 25 °C                       |       | -20   |           | mV /°C |
| DSS                                | Zero Gate Voltage Drain Current  | $V_{DS} = -20 V, V_{GS} = 0 V$                                   |       |       | -1        | μA     |
|                                    |  | $T_{J} = 55^{\circ}C$  |       |       | -10       | μA     |
| GSS                                | Gate - Body Leakage Current  | $V_{GS} = -8 V, V_{DS} = 0 V$                                    |       |       | -100      | nA     |
|                                    | CTERISTICS (Note 2)  |  |       |       |           |        |
| $\Delta V_{GS(th)} / \Delta T_{J}$ | Gate Threshold Voltage Temp. Coefficient   | $I_{D}$ = -250 µA, Referenced to 25 °C                           |       | 1.9   |           | mV /°C |
| V <sub>GS(th)</sub>                | Gate Threshold Voltage   | $V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu {\rm A}$      | -0.65 | -1    | -1.5      | V      |
| R <sub>DS(ON)</sub>                | Static Drain-Source On-Resistance  | $V_{GS} = -2.7 \text{ V}, I_{D} = -0.05 \text{ A}$               |       | 10.6  | 13        | Ω      |
|                                    |  | $V_{GS} = -4.5 \text{ V}, I_{D} = -0.2 \text{ A}$                |       | 7.9   | 10        |        |
|                                    |  | T <sub>J</sub> =125°C  |       | 12    | 18        |        |
| D(ON)                              | On-State Drain Current   | $V_{GS} = -2.7 \text{ V}, V_{DS} = -5 \text{ V}$                 | -0.05 |       |           | А      |
| 9 <sub>FS</sub>                    | Forward Transconductance   | $V_{\rm DS} = -5 \text{ V}, \ \text{I}_{\rm D} = -0.2 \text{ A}$ |       | 0.135 |           | S      |
| DYNAMIC C                          | CHARACTERISTICS  | ·  |       |       |           |        |
| C <sub>iss</sub>                   | Input Capacitance  | $V_{DS} = -10 V, V_{GS} = 0 V,$<br>f = 1.0 MHz                   |       | 11    |           | pF     |
| C <sub>oss</sub>                   | Output Capacitance   | t = 1.0 MHz  |       | 7     |           | pF     |
| C <sub>rss</sub>                   | Reverse Transfer Capacitance   |  |       | 1.4   |           | pF     |
| SWITCHING                          | CHARACTERISTICS (Note 2)   |  |       |       |           |        |
| t <sub>D(on)</sub>                 | Turn - On Delay Time   | $V_{DD} = -6 V, I_{D} = -0.2 A,$                                 |       | 5     | 12        | ns     |
| ţ,                                 | Turn - On Rise Time  | $V_{\rm GS}$ = -4.5 V, $R_{\rm GEN}$ = 50 $\Omega$               |       | 8     | 16        | ns     |
| D(off)                             | Turn - Off Delay Time  |  |       | 9     | 18        | ns     |
| t <sub>f</sub>                     | Turn - Off Fall Time   |  |       | 5     | 10        | ns     |
| Q <sub>g</sub>                     | Total Gate Charge  | $V_{\rm DS} = -5 \text{ V}, \text{ I}_{\rm D} = -0.2 \text{ A},$ |       | 0.22  | 0.31      | nC     |
| Q <sub>gs</sub>                    | Gate-Source Charge   | V <sub>GS</sub> = -4.5 V   |       | 0.12  |           | nC     |
| $Q_{gd}$                           | Gate-Drain Charge  |  |       | 0.05  |           | nC     |
| DRAIN-SOU                          | IRCE DIODE CHARACTERISTICS AND MAXI  | IMUM RATINGS   | 1     |       |           | 1      |
| s                                  | Maximum Continuous Drain-Source Diode For  |  |       |       | -0.7      | A      |
| V <sub>SD</sub>                    | Drain-Source Diode Forward Voltage   | $V_{GS} = 0 V, I_{S} = -0.7 A$ (Note 2)                          |       | -1    | -1.3      | V      |
| design while F                     | m of the junction-to-case and case-to-ambient thermal resistance where $R_{BcA}$ is determined by the user's board design.<br>140°C/W on a 0.125 in <sup>2</sup> pad of 202 copper.<br>Use Width ≤ 300µs, Duty Cycle ≤ 2.0%. | W on a 0.005 in <sup>2</sup> of pad                              |       |       | gut i Gra |        |

FDC6302P Rev.C



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